imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Datasheet revision 1.0

www.chipquik.com

Solder Paste Water-Washable Sn63/Pb37 in 6oz Cartridge 500g T5 Mesh

Product Highlights Printing speeds up to 100mm/sec Long stencil life Wide process window Clear residue Low voiding Excellent wetting compatibility on most board finishes Dispense grade Compatible with enclosed print heads

Sn63/Pb37	
T5	
15-25	
Synthetic Water-Washable	
REL0	
86.5% Metal by Weight	
183°C (361°F)	
6oz/500g Cartridge	
Refrigerated >12 months, Unrefrigerated >6 months	*See notes below:
	T5 15-25 Synthetic Water-Washable REL0 86.5% Metal by Weight 183°C (361°F) 6oz/500g Cartridge

<u>*Shelf Life Notes:</u> Chip Quik® solder paste is good past its quoted shelf life, regardless of refrigeration. Before use, visually inspect the solder paste to ensure it is not dried out or clumpy, or check stencil release. If stored in a jar, stir the product thoroughly for 2-3 minutes before inspection and use.

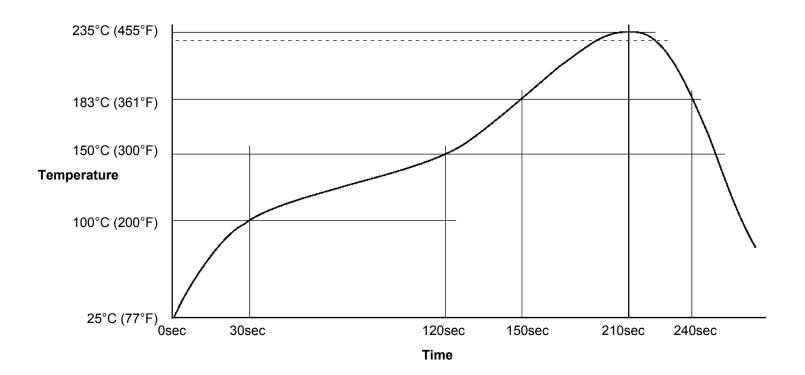
Chip Quik® solder paste is manufactured using Made in USA high quality synthetic flux and precision atomized metal powder. Chip Quik® solder paste is guaranteed for 12 months from date of manufacture, regardless of refrigeration. If you have any issues with our solder paste, please contact Chip Quik® directly for no charge warranty replacement. Please retain original bill of sale, and solder paste in original container as we may request its return for internal R&D testing purposes.

Printer Operation Print Speed: 25-100mm/sec Squeegee Pressure: 70-250g/cm of blade Under Stencil Wipe: Once every 10-25 prints, or as necessary

Stencil Life >8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

Storage and Handling Refrigerate at 3-8°C (37-46°F). Do not freeze. Allow 4 hours for solder paste to reach an operating temperature of 20-25°C (68-77°F) before use.



Test Results

Test Requirement	Result
IPC-TM-650: 2.3.32	L: No breakthrough
IPC-TM-650: 2.6.15	L: No corrosion
IPC-TM-650: 2.3.28.1	L: <0.5%
IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
IPC-TM-650: 2.4.44	37g
IPC-TM-650: 2.4.34.4	Print: 200-275, Dispense: 100-140
IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Electronic Industry Citizenship Coalition (EICC)	Compliant
Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials
	IPC-TM-650: 2.3.32 IPC-TM-650: 2.6.15 IPC-TM-650: 2.3.28.1 IPC-TM-650: 2.6.14.1 IPC-TM-650: 2.6.3.7 IPC-TM-650: 2.4.44 IPC-TM-650: 2.4.34.4 IPC-TM-650: 3.4.2.5 Electronic Industry Citizenship Coalition (EICC) Articles 33 and 67 of Regulation (EC)

Conforms to the following Industry Standards:	
J-STD-004B, Amendment 1 (Solder Fluxes):	Yes
J-STD-005A (Solder Pastes):	Yes
J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):	Yes
RoHS 2 Directive 2011/65/EU:	No